


Features

- $BV_{CEO} > 65V$
- $I_C = 100mA$ High Continuous Collector Current
- Low-Profile, 0.6mm-High Package for Thin Applications
- Sidewall Tin Plating for Wettable Flanks in AOI
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **An automotive-compliant part is available under a separate datasheet ([BC846BFHWQ](#)).**

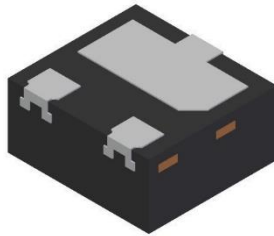
Mechanical Data

- Package: U-DFN1110-3/SWP
- Package Material: Molded Plastic. "Green" Molding Compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 
- Weight: 0.001714 grams (Approximate)

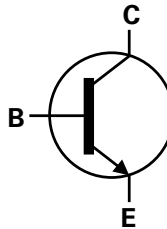
Application

- Switching and amplification

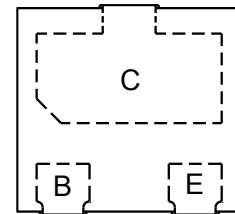
U-DFN1110-3/SWP (Type A)



Bottom View



Device Symbol



Top View
Pin-Out

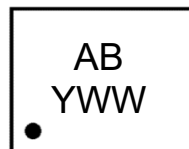
Ordering Information (Note 4)

| Orderable Part Number | Package | Marking | Reel Size (inches) | Tape Width (mm) | Packing | |
|-----------------------|--------------------------|---------|--------------------|-----------------|---------|---------|
| | | | | | Qty. | Carrier |
| BC846BFHW-7 | U-DFN1110-3/SWP (Type A) | 4L | 7 | 8 | 5,000 | Reel |

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information

U-DFN1110-3/SWP (Type A)



AB = Product type Marking Code
YWW = Date Code Marking
Y = Last Digit of Year (ex: 5 = 2025)
WW = Week Code 01 to 53

Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|------------------------------|------------------|-------|------|
| Collector-Base Voltage | V _{CBO} | 80 | V |
| Collector-Emitter Voltage | V _{CEO} | 65 | V |
| Emitter-Base Voltage | V _{EB0} | 6 | V |
| Continuous Collector Current | I _C | 100 | mA |
| Peak Pulse Collector Current | I _{CM} | 200 | mA |
| Peak Base Current | I _{BM} | 100 | mA |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Power Dissipation (Note 5) | P _D | 420 | mW |
| Thermal Resistance, Junction to Ambient (Note 5) | R _{θJA} | 298 | °C/W |
| Thermal Resistance, Junction to Case (Note 6) | R _{θJC} | 109 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +150 | °C |

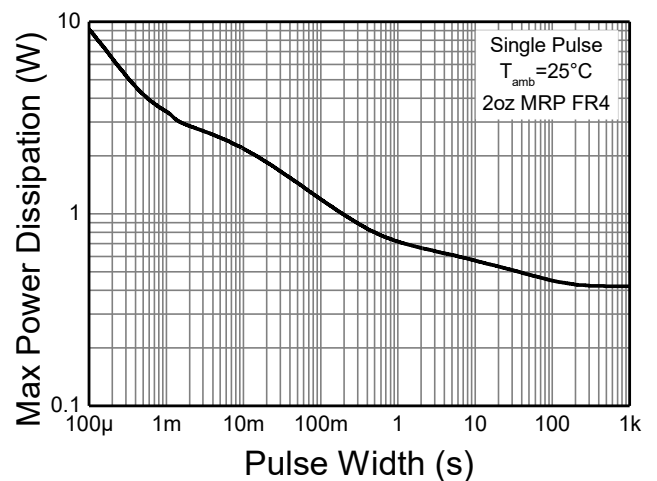
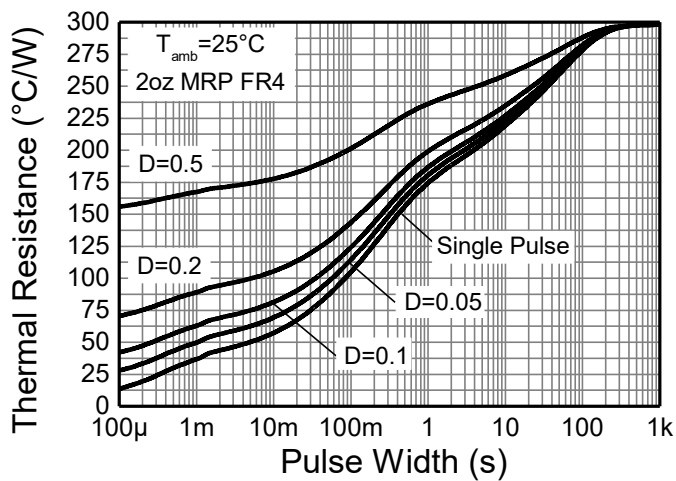
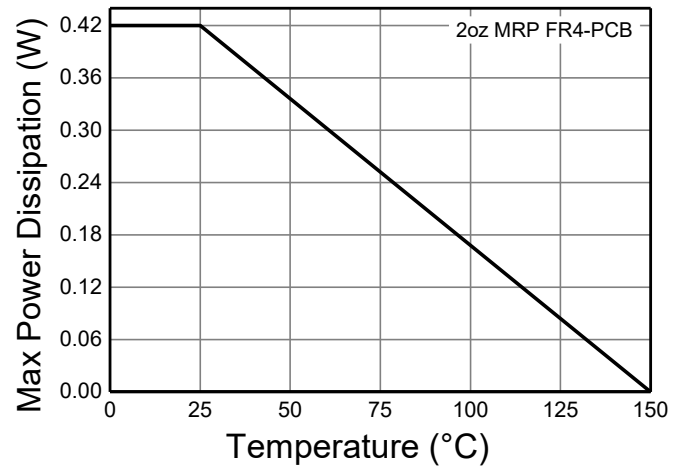
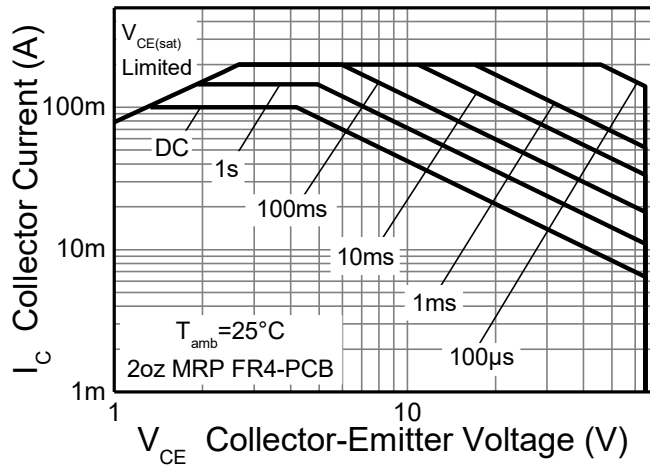
ESD Ratings (Note 7)

| Characteristic | Symbol | Value | Unit | JEDEC Class |
|--|---------|-------|------|-------------|
| Electrostatic Discharge – Human Body Model | ESD HBM | 4000 | V | 3A |
| Electrostatic Discharge – Charged Device Model | ESD CDM | 1000 | V | C3 |

Notes:

5. For a device mounted with the exposed collector pads on minimum recommended pad layout and 2oz. copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
6. Thermal resistance from junction to the top of the case.
7. Refer to JEDEC specification JESD22-A114 and JESD22-C101.

Thermal Characteristics and Derating Information

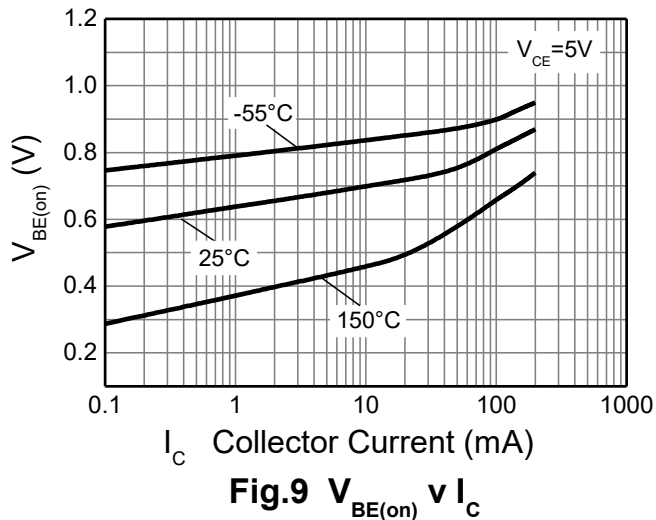
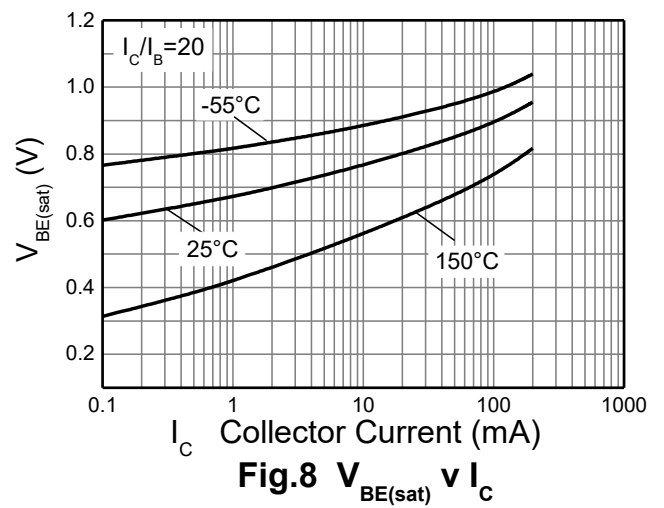
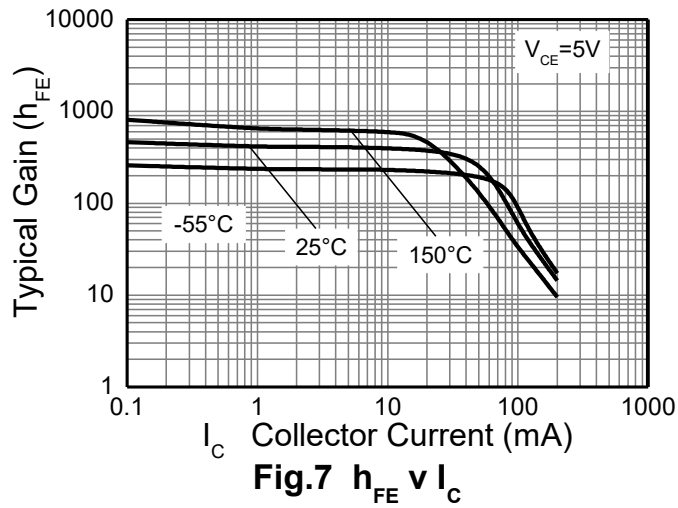
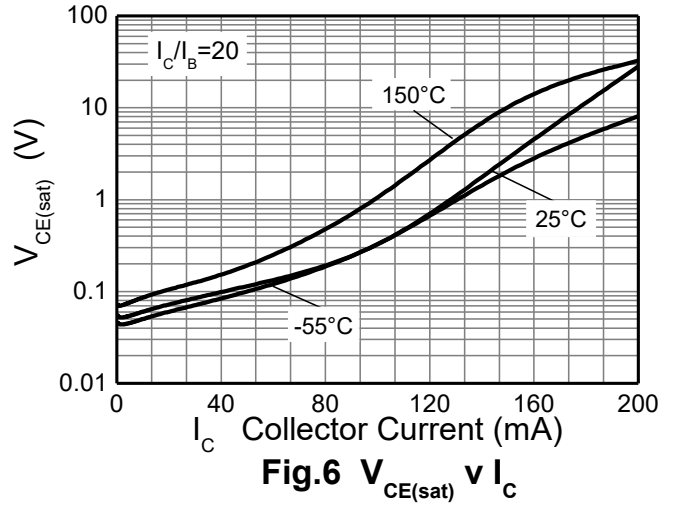
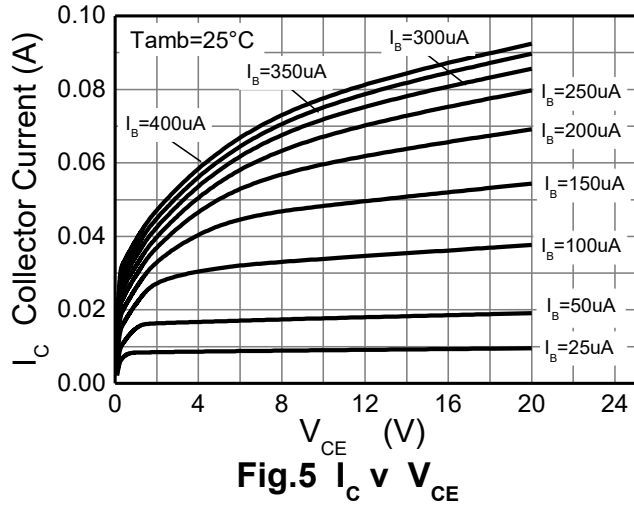


Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Conditions |
|---|----------------------|-----|-----|-----|------|---|
| Collector-Base Breakdown Voltage | BV _{CBO} | 80 | — | — | V | I _C = 100μA |
| Collector-Emitter Breakdown Voltage (Note 8) | BV _{CEO} | 65 | — | — | V | I _C = 10mA |
| Emitter-Base Breakdown Voltage | BV _{EBO} | 6 | — | — | V | I _E = 100μA |
| Collector-Base Cutoff Current | I _{CBO} | — | — | 15 | nA | V _{CB} = 30V, I _E = 0 |
| | | — | — | 5 | μA | V _{CB} = 30V, I _E = 0, T _A = +150°C |
| Emitter-Base Cutoff Current | I _{EBO} | — | — | 100 | nA | V _{EB} = 6V, I _C = 0 |
| DC Current Gain (Note 8) | h _{FE} | 200 | — | 450 | — | V _{CE} = 5V, I _C = 2mA |
| Collector-Emitter Saturation Voltage (Note 8) | V _{CE(sat)} | — | — | 200 | mV | I _C = 10mA, I _B = 0.5mA |
| | | — | — | 400 | | I _C = 100mA, I _B = 5mA |
| Base-Emitter Turn-on Voltage (Note 8) | V _{BE(on)} | 580 | — | 700 | mV | V _{CE} = 5V, I _C = 2mA |
| | | — | — | 770 | | V _{CE} = 5V, I _C = 10mA |
| Base-Emitter Saturation Voltage (Note 8) | V _{BE(sat)} | — | 760 | — | V | I _C = 10mA, I _B = 0.5mA |
| | | — | 900 | — | | I _C = 100mA, I _B = 5mA |
| Transition Frequency | f _T | 100 | — | — | MHz | V _{CE} = 5V, I _C = 10mA, f = 100MHz |
| Output (Collector) Capacitance | C _{obc} | — | — | 3 | pF | V _{CB} = 10V, f = 1MHz |
| Output (Emitter) Capacitance | C _{oec} | — | 11 | — | pF | V _{EB} = 0.5V, f = 1MHz |
| Noise Figure | NF | — | — | 10 | dB | V _{CE} = 5V, I _C = 200μA, R _S = 2kΩ, f = 1kHz BW=200Hz |

Note: 8. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.

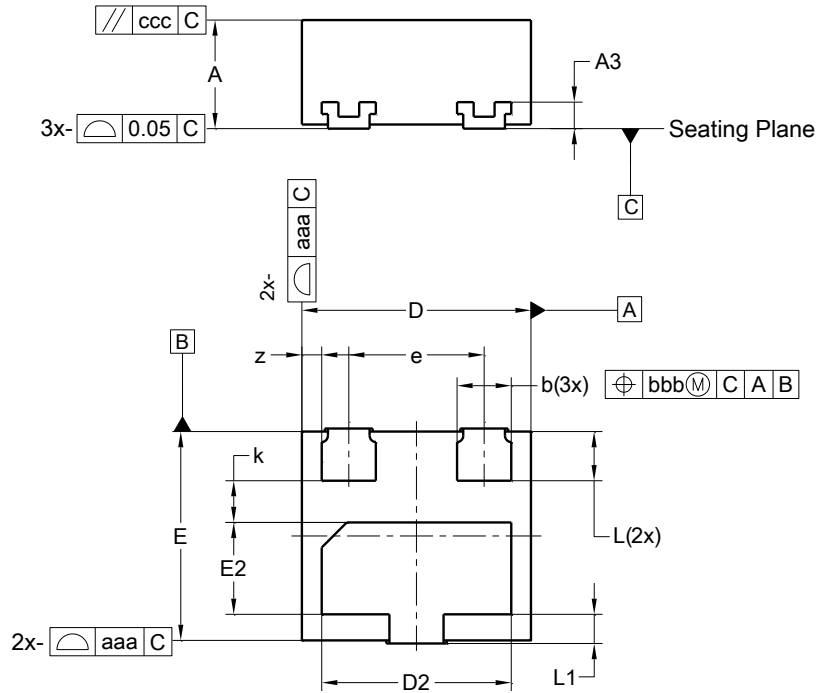
Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

U-DFN1110-3/SWP (Type A)



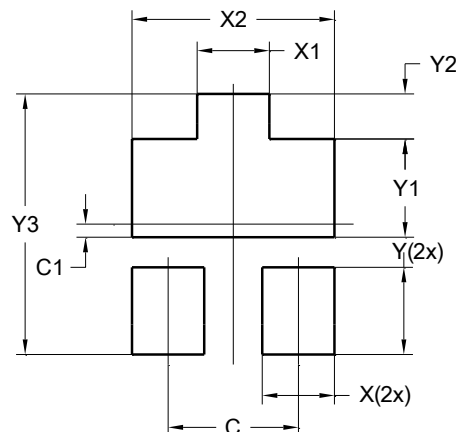
| U-DFN1110-3/SWP (Type A) | | | |
|-----------------------------|----------|------|-------|
| Dim | Min | Max | Typ |
| A | 0.47 | 0.57 | 0.52 |
| A1 | 0.00 | 0.05 | 0.03 |
| A3 | — | — | 0.127 |
| b | 0.22 | 0.30 | 0.26 |
| D | 1.05 | 1.15 | 1.10 |
| D2 | 0.87 | 0.95 | 0.91 |
| e | 0.65 BSC | | |
| E | 0.95 | 1.05 | 1.00 |
| E2 | 0.40 | 0.48 | 0.44 |
| k | — | — | 0.20 |
| L | 0.20 | 0.27 | 0.23 |
| L1 | 0.09 | 0.19 | 0.14 |
| z | — | — | 0.095 |
| aaa | 0.25 | | |
| bbb | 0.10 | | |
| ccc | 0.10 | | |
| All Dimensions in mm | | | |

Note: Side wall tin plated package for wettable flanks in AOI.

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

U-DFN1110-3/SWP (Type A)



| Dimensions | Value (in mm) |
|------------|------------------|
| C | 0.650 |
| C1 | 0.065 |
| X | 0.360 |
| X1 | 0.360 |
| X2 | 1.010 |
| Y | 0.435 |
| Y1 | 0.490 |
| Y2 | 0.225 |
| Y3 | 1.300 |

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